

March 25, 2004

To: Commissioner of Patents and Trademarks
Washington, D.C. 20231

Fr: George O. Saile Reg. No. 19,572
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Continuation of
Serial No.: 10/060,483 1/30/02

YEN-MING CHEN, CHIA-FU LIN, SHUN-LIANG,
KAI-MING CHING, HSIN-HUI LEE, CHAO-YUAN SU, LI-
CHIH CHEN

NOVEL METHOD TO IMPROVE BUMP RELIABILITY
FOR FLIP CHIP DEVICE

PRELIMINARY AMENDMENT

Dear Sir:

This is a preliminary amendment for the above referenced Continuation. Please
amend the above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States
Postal Service as first class mail in an envelope addressed to: Commissioner of Patents
and Trademarks, Washington, D.C. 20231, on March 26, 2004.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date



3/26/04

Continuation Application of

Appl. No : 10/060,483
Applicant : Yen-Ming Chen
Filed : 01/30/02
TC/A.U. : 2814
EXAMINER : Trinh, Hoa B.

Docket No. : TS01-413C
Customer No.: 28112

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Please enter the attached Preliminary Amendment.

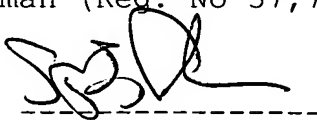
Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments are shown on page 6 of this paper.

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Stephen B. Ackerman (Reg. No 37,761)



Signature

3/26/04

Date